



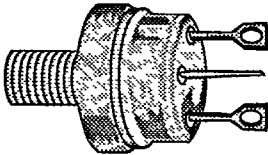
2N6962 T-39-13

N-Channel Enhancement Mode Transistor
QPL product is in accordance with MIL-S-19500/568

TO-210AC (TO-61)
Isolated Case

This device contains beryllium oxide

TOP VIEW



1 SOURCE
2 GATE
3 DRAIN

PRODUCT SUMMARY

$V_{(BR)DSS}$ (V)	$r_{DS(ON)}$ (Ω)	I_D (A)
100	0.060	30

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	± 30	
Continuous Drain Current	$T_C = 25^\circ\text{C}$	I_D	30	A
	$T_C = 100^\circ\text{C}$		24	
Pulsed Drain Current ¹		I_{DM}	120	
Power Dissipation	$T_C = 25^\circ\text{C}$	P_D	150	W
	$T_C = 100^\circ\text{C}$		60	
Operating Junction & Storage Temperature Range		T_J, T_{stg}	-55 to 150	$^\circ\text{C}$
Lead Temperature (¹ / ₁₆ " from case for 10 sec.)		T_L	300	

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THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	R_{thJC}		0.83	K/W
Junction-to-Ambient	R_{thJA}		40	
Case-to-Sink	R_{thCS}	0.4		

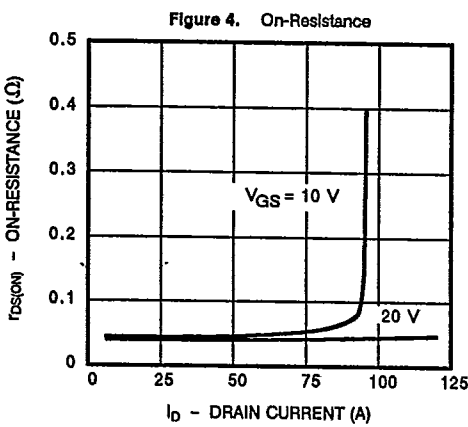
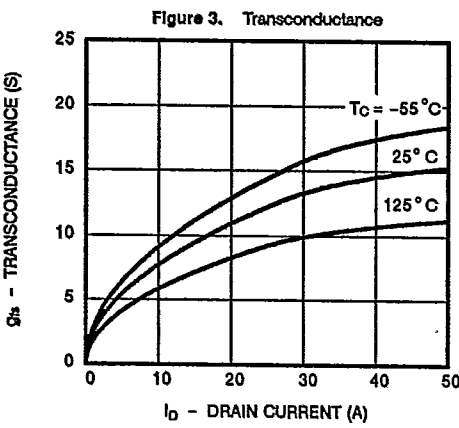
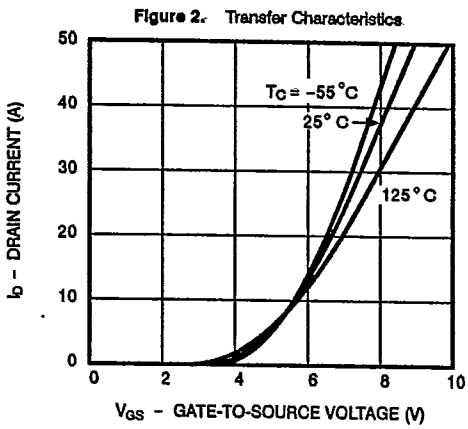
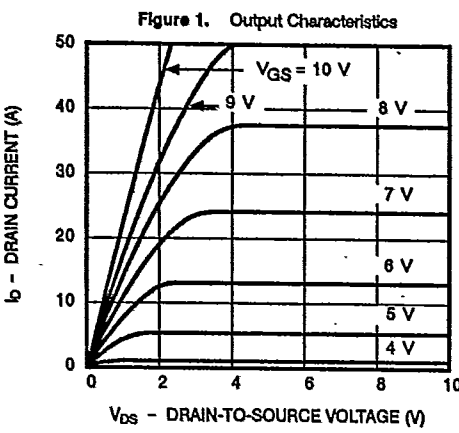
¹Pulse width limited by maximum junction temperature (refer to transient thermal impedance data, Figure 11).



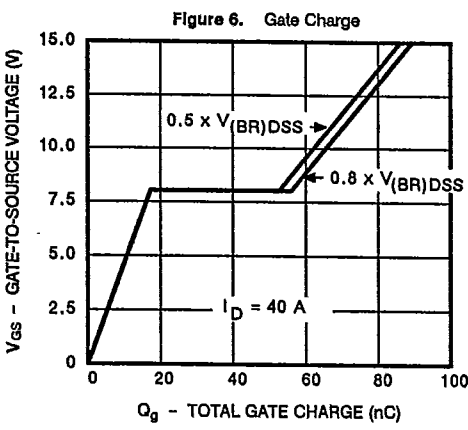
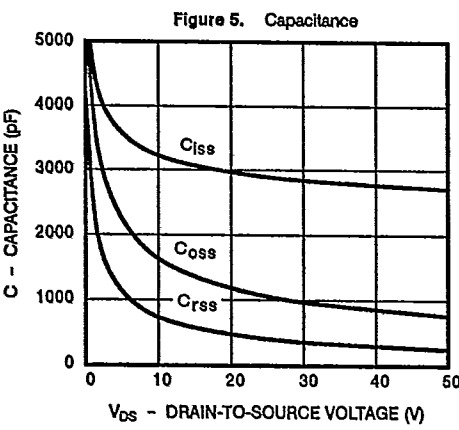
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TYPICAL CHARACTERISTICS (25°C Unless Otherwise Specified)

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TYPICAL CHARACTERISTICS (Cont'd)

T-39-13

Figure 7. On-Resistance vs. Junction Temperature

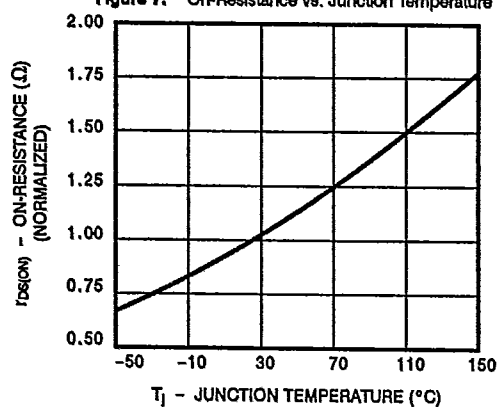
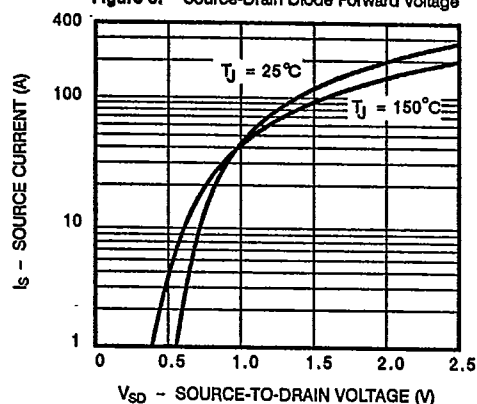


Figure 8. Source-Drain Diode Forward Voltage



THERMAL RATINGS

Figure 9. Maximum Drain Current vs. Case Temperature vs. Case Temperature

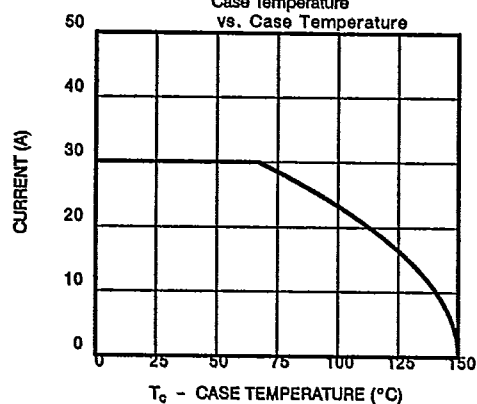


Figure 10. Safe Operating Area

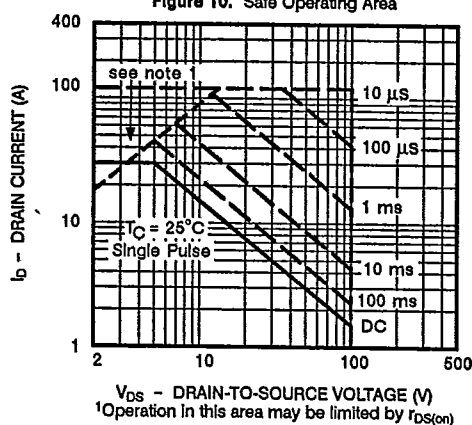


Figure 11. Normalized Effective Transient Thermal Impedance, Junction-to-Case

